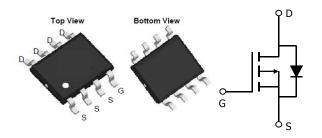


General Description

The KSP4407A series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible onresistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

SOP-8 Pin Configuration



Product Summary

V _{DS} (V)	$R_{DS(on)}$ (m Ω)	I _D (A)
-30	10 at VGS = 10 V	-13
	16 at Vgs = 4.5 V	-9.5

Features

- High Power and current handing capability
- Lead free product is acquired
- Surface mount package

Applications

- PWM applications
- Load switch
- Power management

Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-30	V
V _{GS}	Gate-Source Voltage	±20	V
	Drain Current – Continuous (T _C =25℃)	-13	А
D	Drain Current – Continuous (Tc=100℃)	-8.5	А
рм	Drain Current – Pulsed¹	-45	А
P_{D}	Power Dissipation (Tc=25°C)	3	W
	Power Dissipation (T _C =100°C)	0.05	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
Гл	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		45	°C/W
Rejc	Thermal Resistance Junction to Case		3.5	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted) Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V
I _{DSS}	Drain-Source Leakage Current	V_{DS} =-25V , V_{GS} =0V , T_{J} =25°C			-1	uA
		V _{DS} =-25V , V _{GS} =0V , T _J =125℃			-10	uA
lgss	Gate-Source Leakage Current	V_{GS} = $\pm 20V$, V_{DS} = $0V$			±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V , I _D =-5A		10	14	mΩ
		V _{GS} =-4.5V , I _D =-3A		16	23	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	-1.0	-1.3	-3	V
gfs	Forward Transconductance	V _{DS} =-15V , I _S =-4A		20		S

Dynamic and switching Characteristics

Q_g	Total Gate Charge		 26	
Qgs	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-10V , I _D =-10A	 4.1	 nC
Q_gd	Gate-Drain Charge		 7	
$T_{d(on)}$	Turn-On Delay Time		 11	
Tr	Rise Time	Vps=-15V, lp=-10A	 10	 ns
$T_{d(off)}$	Turn-Off Delay Time	V _G s=-10V,R _G =1Ω	 38	 113
T _f	Fall Time		 12	
Ciss	Input Capacitance		 1850	
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , F=1MHz	 240	 pF
C _{rss}	Reverse Transfer Capacitance		 195	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	V _G =V _D =0V , Force Current			-13	Α
I _{SM}	Pulsed Source Current				-25	Α
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =-1A , T _J =25℃			-1.2	V

Note:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production
- **5.** E_{AS} condition: Tj=25 $^{\circ}$ C,V_{DD}=-15V,V_G=10V,L=0.5mH,Rg=25 Ω , I_{AS}=-34A



Typical Electrical and Thermal Characteristics (Curves)

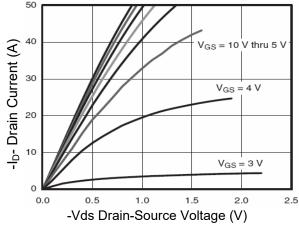


Fig.1 Output Characteristics

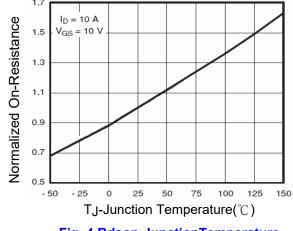


Fig. 4 Rdson-JunctionTemperature

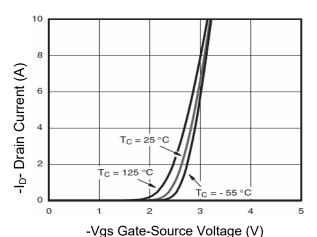


Fig. 2 Transfer Characteristics

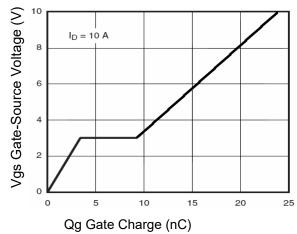


Fig. 5 Gate Charge

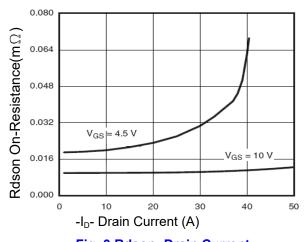


Fig. 3 Rdson- Drain Current

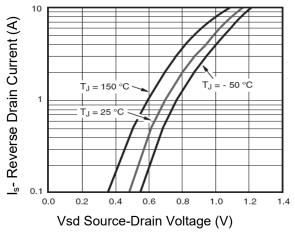
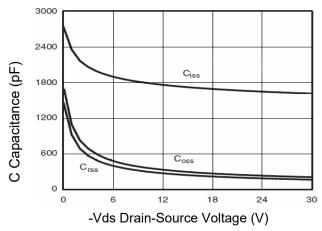


Fig. 6 Source- Drain Diode Forward





Figu.7 Capacitance vs Vds

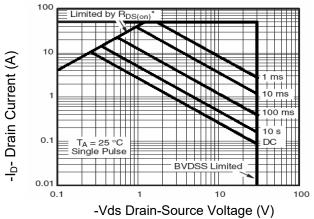


Fig.9 Safe Operation Area

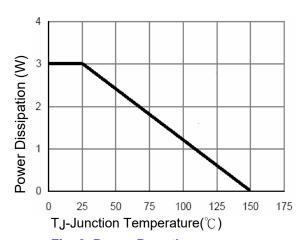


Fig. 8 Power De-rating

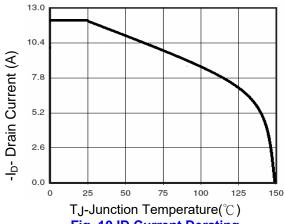


Fig. 10 ID Current Derating

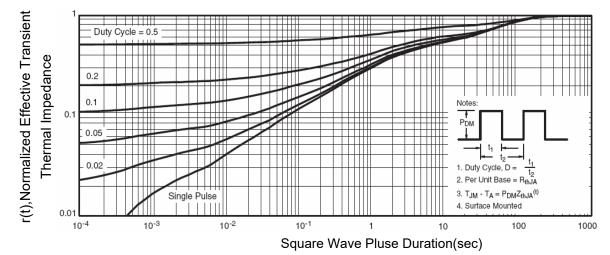


Fig.11 Normalized Maximum Transient Thermal Impedance



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